

DOCKET NO. 94-C-096C4 (STMI01-94096)

PATENT

Customer No. 30425

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In application of: : KUEI-WU HUANG ET AL
Serial No. : 09/517,987
Filed : March 3, 2000
For : METHOD OF FORMING PLANARIZED STRUCTURES IN
AN INTEGRATED CIRCUIT
Group No. : 2812
Examiner : R.A. Booth

MAIL STOP AF

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

CERTIFICATE OF MAILING BY FIRST CLASS MAIL

Sir:

The undersigned hereby certifies that the following documents:

1. Response to Office Action;
2. Notice of Appeal;
3. Check in the amount of \$330.00 for the Notice of Appeal filing fee; and
4. A postcard receipt;

relating to the above application, were deposited as "First Class Mail" with the United States Postal Service, addressed to MAIL STOP AF, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on February 6, 2004.

Date: 2-6-04

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